

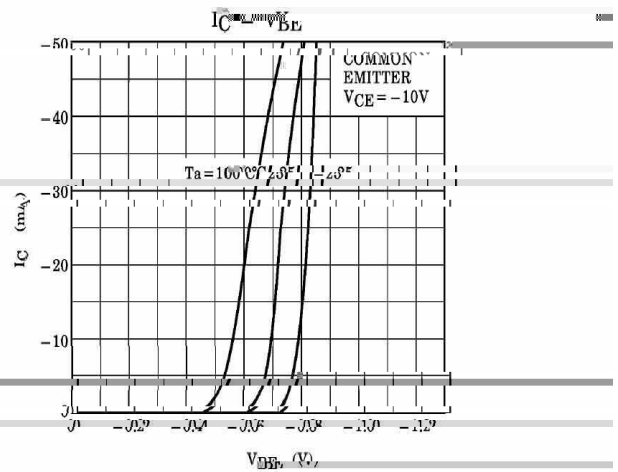
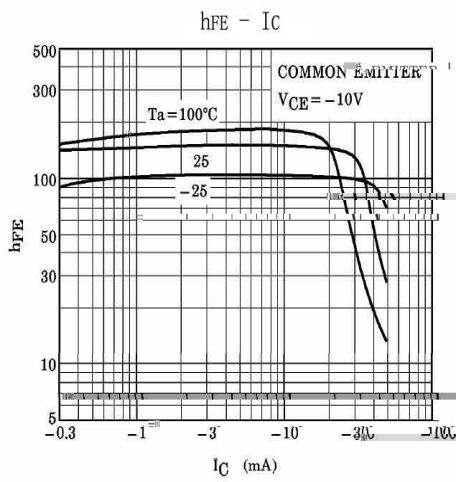
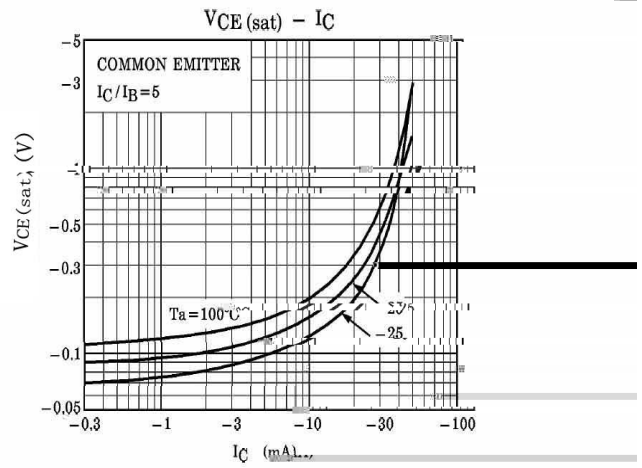
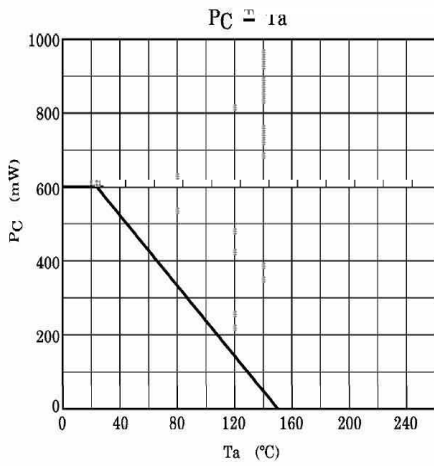
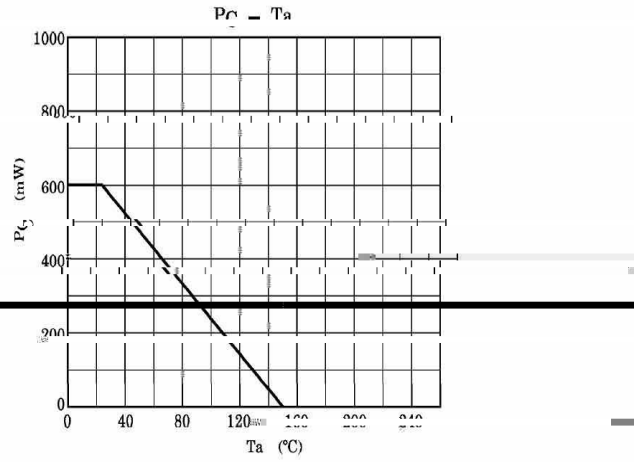
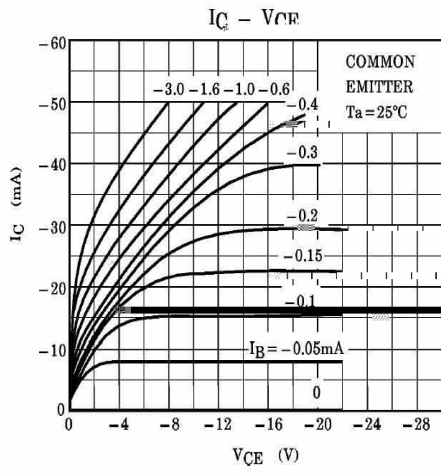
/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-250	V
Collector to Emitter Voltage	V_{CEO}	-250	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current - Continuous	I_C	-50	mA
Collector Current – Continuous(Pulse)	I_{CP}	-100	mA
Base Current - Continuous	I_B	-20	mA
Collector Power Dissipation	P_C	600	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

/ Electrical Characteristics(Ta=25)

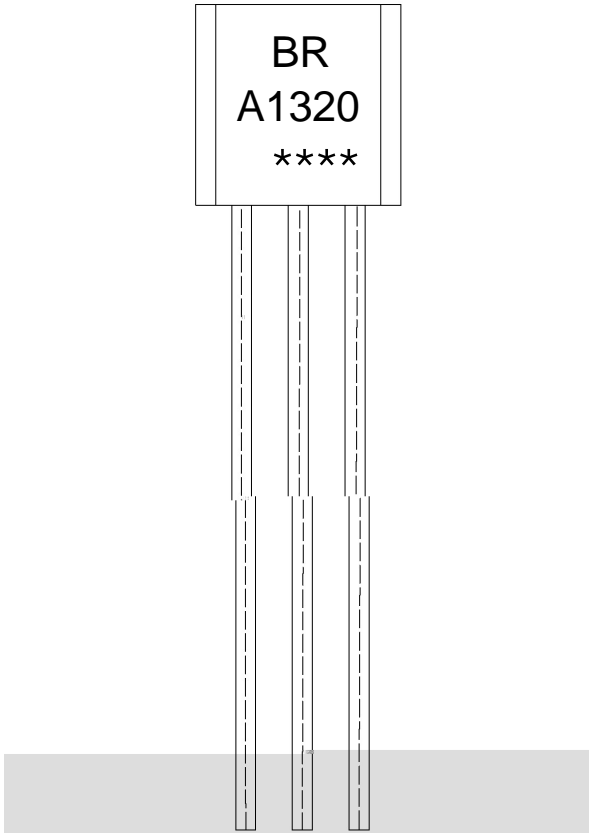
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector Cut-Off Current	I_{CBO}	$V_{CB}=-200V$ $I_E=0$			-1.0	μA
Emitter Cut-Off Current	I_{EBO}	$V_{EB}=-5.0V$ $I_C=0$			-1.0	μA
Collector to Emitter Breakdown Voltage	V_{CEO}	$I_C=-1.0mA$ $I_B=0$	-250			V
DC Current Gain	h_{FE}	$V_{CE}=-20V$ $I_C=-25mA$	50			
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-10mA$ $I_B=-1.0mA$			-1.5	V
Base to Emitter Voltage	V_{BE}	$V_{CE}=-20V$ $I_C=-25mA$		-0.75		V
Transition Frequency	f_T	$V_{CE}=-10V$ $I_C=-10mA$	60	80		MHz
Reverse Transfer Capacitance	C_{re}	$V_{CB}=-30V$ $I_E=0$ $f=1.0MHz$			1.8	pF

/ Electrical Characteristic Curve



2SA1320

/ Marking Instructions



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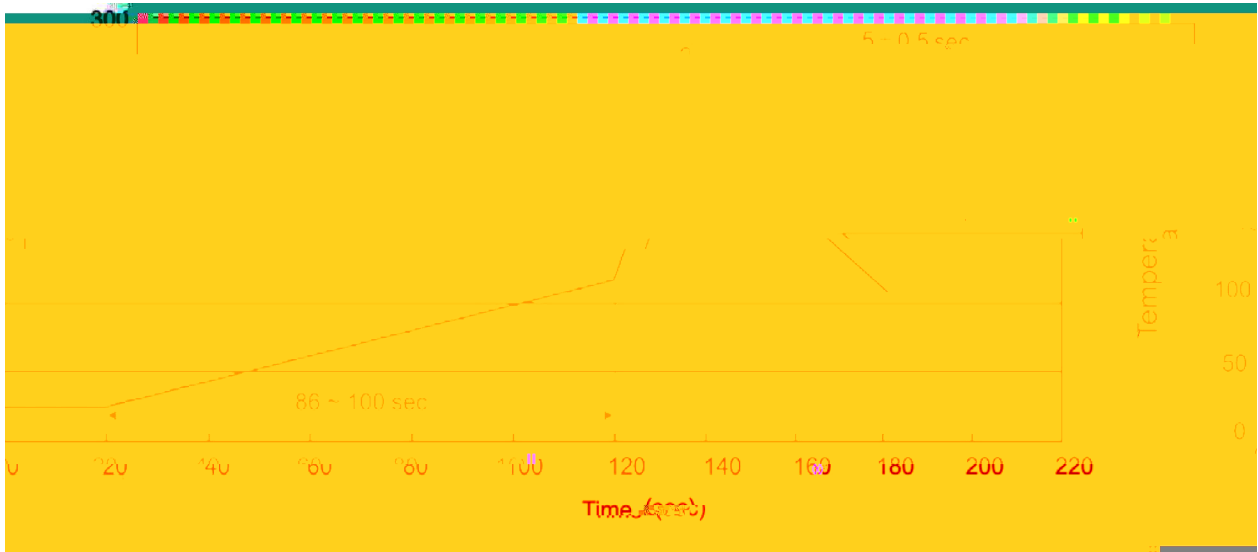
Note:

BR: Company Code.

A1320: Product Type.

****: Lot No. Code,code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



Note:

- | | | | |
|---|--------|------------|---|
| 1 | 25 150 | 60 90sec; | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 255..5 | 5..0.5sec; | 2.Peak Temp.:255..5 , Duration:5..0.5sec. |
| 3 | 2 10 | /sec. | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270..5 10..1 sec. Temp:270±5 Time:10±1 sec

/ Packaging SPEC.

/ BULK

dBW(37#y